

# 3G Band RF Linear LDMOS Amplifier

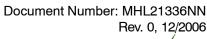
Designed for ultra-linear amplifier applications in 50 ohm systems operating in the 3G frequency band. A silicon FET Class A design provides outstanding linearity and gain. In addition, the excellent group delay and phase linearity characteristics are ideal for digital CDMA modulation systems.

- Third Order Intercept: 45 dBm Typ
- Power Gain: 31 dB Typ (@ f = 2140 MHz)
- Input VSWR  $\leq 1.5$ :1

### Features

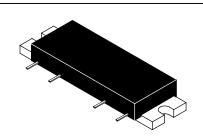
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- · Excellent Phase Linearity and Group Delay Characteristics
- Ideal for Feedforward Base Station Applications
- RoHS Compliant



## MHL21336NN

2110-2170 MHz 3.0 W, 31 dB RF LINEAR LDMOS AMPLIFIER



CASE 301AP-02, STYLE 1

### Table 1. Absolute Maximum Ratings (T<sub>C</sub> = 25°C unless otherwise noted)

<b>.</b>			
Rating	Symbol	Value	Unit
DC Supply Voltage	V <sub>DD</sub>	30	Vdc
RF Input Power	P <sub>in</sub>	+5	dBm
Storage Temperature Range	T <sub>stg</sub>	- 40 to +100	°C
Operating Case Temperature Range	T <sub>C</sub>	- 20 to +100	°C

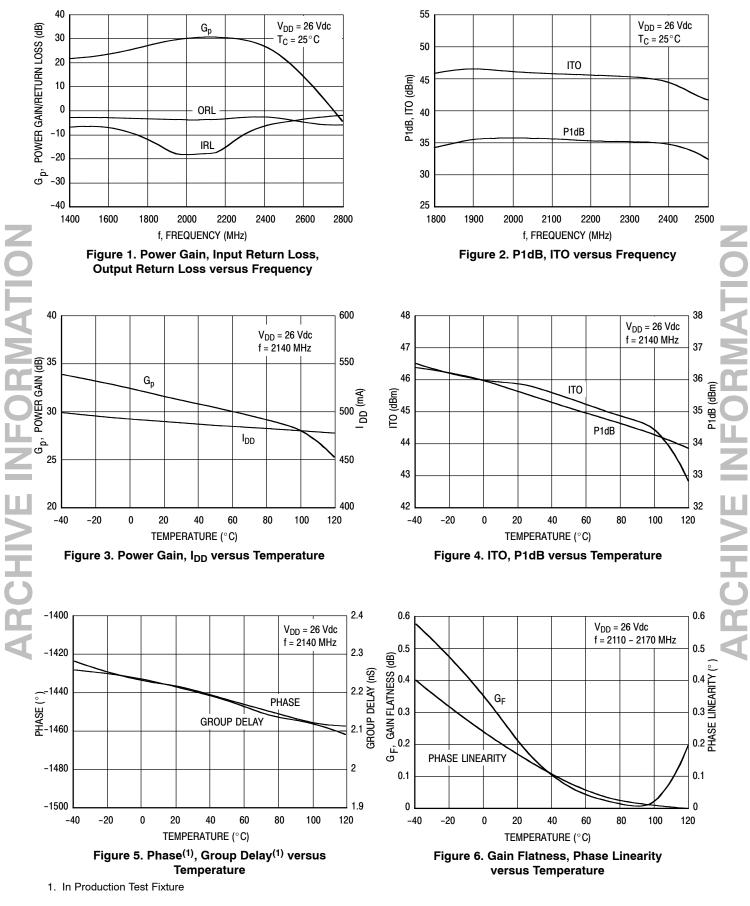
### Table 2. Electrical Characteristics (V<sub>DD</sub> = 26 Vdc, T<sub>C</sub> = 25°C; 50 $\Omega$ System)

Characteristic	Symbol	Min	Тур	Max	Unit	
Supply Current		I <sub>DD</sub>	_	500	525	mA
Power Gain	(f = 2140 MHz)	Gp	30	31	33	dB
Gain Flatness	(f = 2110 - 2170 MHz)	G <sub>F</sub>	_	0.15	0.4	dB
Power Output @ 1 dB Compression	(f = 2140 MHz)	P1dB	34	35	—	dBm
Third Order Intercept (f1 = 2137 MHz, f2 = 2142 MHz)		ITO	44	45	—	dBm
Noise Figure	(f = 2170 MHz)	NF	—	4.5	5	dB

NOTE - **CAUTION** - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.



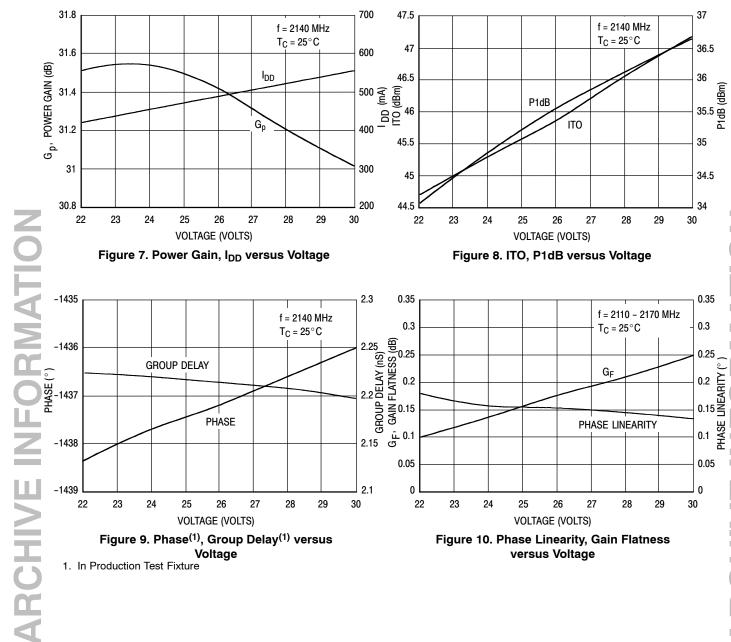
### **TYPICAL CHARACTERISTICS**



MHL21336NN

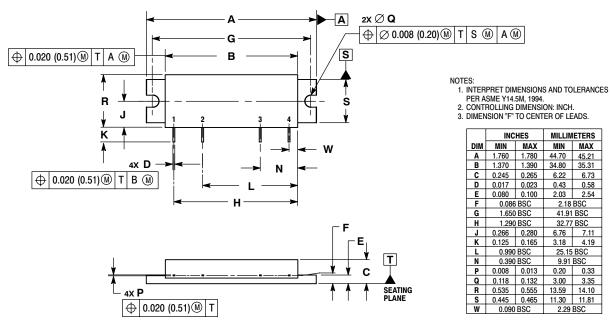


**TYPICAL CHARACTERISTICS** 





### PACKAGE DIMENSIONS



3. DIMENSION "F" TO CENTER OF LEADS. INCHES MILLIMETERS MIN MAX MIN MAX 1.780 44.70 45.21 34.80 35.31 1.370 1.390 0.245 0.265 6.22 6.73 0.017 0.023 0.080 0.100 0.43 0.58 2.03 2.54 0.086 BSC 1.650 BSC 2.18 BSC 41.91 BSC 1.290 BSC 32.77 BSC 
 J
 0.266
 0.280

 K
 0.125
 0.165

 L
 0.990 BSC
6.76 7.11 3.18 4.19 25.15 BSC

N	0.390 BSC		9.91 BSC		
Р	0.008	0.013	0.20	0.33	
Q	0.118	0.132	3.00	3.35	
R	0.535	0.555	13.59	14.10	
S	0.445	0.465	11.30	11.81	
W	0.090 BSC		2.29 BSC		
STYL	STYLE 1:				

**ARCHIVE INFORMATION** 

PIN 1. RF INPUT 2. VDD1 3. VDD2 4. RF OUTPUT CASE: GROUND

CASE 301AP-02 **ISSUE E** 

### MHL21336NN



### **REVISION HISTORY**

The following table summarizes revisions to this document.

Revision	Date	Description	
0	Dec. 2006	Initial Release of Data Sheet	



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